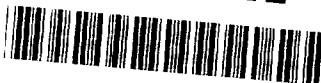


04-17-2002

Form PTO-1595  
(Rev. 03/01)  
OMB No. 0651-0027 (exp. 5/31/2002)

RECC



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U.S. DEPARTMENT OF COMMERCE  
U.S. Patent and Trademark Office

Attorney Docket No. 740819-776

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

## 1. Name of conveying parties:

Masahiro OGAWA  
Masahiro ISHIDA  
Satoshi TAMURA  
Sinichi TAKIGAWA

## 2. Name and address of receiving party(ies)

Name: Matsushita Electric Industrial Co., Ltd.Internal Address: 1006, Oaza Kadoma, Kadoma-shi,Osaka 571-8501, JapanAdditional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

## 3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other \_\_\_\_\_

Street Address: \_\_\_\_\_

City: \_\_\_\_\_ State: \_\_\_\_\_ Zip: \_\_\_\_\_

Country: \_\_\_\_\_ Postal Code: \_\_\_\_\_

Execution Date: April 9, 2002Additional name(s) & address(es) attached? ☐ Yes ☒ No

## 4. Application number(s) or patent number(s);

If this document is being filed together with a new application, the execution date of the application is: April 9, 2002

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☐ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Attorney Name: Eric J. RobinsonFirm Name: Nixon Peabody LLPInternal Address: Suite 800Street Address: 8180 Greensboro Drive,City: McLean State: VA Zip: 221027. Total number of applications and patents involved: 1

## 8. Total fee (37 CFR 3.41) .....\$40.00

☒ Enclosed☐ Authorized to be charged to deposit account

## 6. Submission Type

- ☒ New  
☐ Resubmission (Non-Recordation)  
Document ID# \_\_\_\_\_  
☐ Correction of PTO Error  
Reel # \_\_\_\_\_ Frame # \_\_\_\_\_  
☐ Corrective Document  
Reel # \_\_\_\_\_ Frame # \_\_\_\_\_

## 9. Deposit account number:

19-2380

(Attach duplicate copy of this page if paying by deposit account)

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## 10. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Eric J. Robinson

Name of Person Signing

Signature

April 10, 2002

Date

Total number of pages including cover sheet, attachments, and documents: 3

Mail documents to be recorded with required cover sheet information to:  
Commissioner of Patents & Trademarks, Box Assignments  
Washington, D.C. 20231

04/11/2002 RHAR351 00000028 10118924

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**PATENT**  
**REEL: 012787 FRAME: 0876**

## ASSIGNMENT

WHEREAS, Masahiro OGAWA, Masahiro ISHIDA, Satoshi TAMURA,  
Shinichi TAKIGAWA  
(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements  
in METHOD FOR FABRICATING GROUP III NITRIDE SEMICONDUCTOR SUBSTRATE

\_\_\_\_\_ for which the undersigned has (have):

- (a) filed an application for Letters Patent of the United States of America on  
\_\_\_\_\_ having Serial No. \_\_\_\_\_; or
- (b) executed an application for Letters Patent of the United States of America on the date(s)  
indicated below; and

WHEREAS, Matsushita Electric Industrial Co., Ltd. of  
1006, Oaza Kadoma, Kadoma-shi, Osaka 571-8501, Japan  
its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is  
desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters  
Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in  
hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the  
undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer  
unto the Assignee the full and exclusive right to the said invention in the United States of America and  
its territories and for all foreign countries, dependencies and possessions and the entire right, title and  
interest in and to the application and any and all Letters Patent(s) which may be granted therefor in the  
United States of America and its territories, dependencies and possessions, and in and to any and all  
divisions, reissues, continuations and extensions thereof for the full term or terms for which the same  
may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application  
and any continuing, divisional or reissue applications thereof and also to execute separate assignments  
in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference  
which may be declared concerning this application or any continuation, division or reissue thereof or  
Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way  
possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which  
may be necessary in connection with claims under or provisions of the International Convention for the  
Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to the Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

This Assignment has been executed by the undersigned on the date(s) indicated.

Date: April 9, 2002, Masahiro Ogawa  
**Masahiro OGAWA**

Date: April 9, 2002, Masahiro Ishida  
**Masahiro ISHIDA**

Date: April 9, 2002, Satoshi Tamura  
**Satoshi TAMURA**

Date: April 9, 2002, Shinichi Takigawa  
**Shinichi TAKIGAWA**

Date: \_\_\_\_\_, \_\_\_\_\_

Date: \_\_\_\_\_, \_\_\_\_\_

Date: \_\_\_\_\_, \_\_\_\_\_

Date: \_\_\_\_\_, \_\_\_\_\_